	Material Compo © Copyright 2005. II S INDUSTRIES® international and Part	PC. Bannockb	ourn. Illinois. A	All rights reserved untions.	inder both	This docume level parts, t	ent is a declaration	tion of th encompa	ne substances asses all low	s within the 1 er level mate	nanufacture rials for wh	er listed it nich the m	em. Note: if anufacturer	the item is an as has engineering	ssembly with low responsibility.
752-21.1	1.1 IPC Web Site for Information on IPC-1752 Standard Form Type Distribute				*	Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Information					on				
upplie	r Information														
Company name* Company unique ID					Unique ID Authority					Response Date*					
nsemi												2025-08-	31		
Contact N	lame		Title - Contact]	Phone - Contact*					Email - Contact*			
Product-l	Env-Stewards		Product Enviro Compliance				NA					Product-Env-Stewards@onsemi.com			
Authorized Representative*			Title - Representative]	Phone - Representative*				Email - Representative*				
Product-Env-Stewards Pro			Product Envi	ro Compliance		NA Product-Env-Stewards@onsemi.com					om				
	Requester Item Number Mfr Item		Number	Mfr Item Name Effective Date Version Manufa			Manufacturi	ng Site	Weight*		UOM	Unit Type			
		NXV08F	1350XT1	APM17-MDC, M	IV7 80V, ALN, 2	2 Phase	2025-08-31			СРА		2	1180.17	mg	Each
Ianufa	cturing Proccess Informat	tion						-							
	Terminal Plating / Grid Array Material T			Alloy	J-STD-020 MSL F		Peak Process Body Temperat		ure Max Time at Peak Tem		Temperatu	ire Numbe	er of Reflow Cy	cles	
Matte Tin (Sn) - annealed CU Alloy]	NA		0		С	30		second	ls 3				
omments	6														
or more	information regarding material	composition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed
Directive 2015/863/EU amending RoHS Directive 2011/65/EU		mium (Cr6+), Polybrominated Biphenyls (dmium and quantity limit of 0.1% by mass (100 minated Diphenyl Ethers (PBDE), and Bis(2-ethers)	
cadmium, hexavalentchromium, polybromina contains a RoHS restricted substance inexcess encompass all such components.Supplier cert as of the date that Supplier completes this for Company acknowledges that Supplier may ha independently verified information provided certification in this paragraph.If the Company	ted biphenyls and/or polybrominated dip of an applicable quantity limit, please in ifies that it gathered the information it pr m.Supplier acknowledges that Company ve relied on informationprovided by oth by others, Supplier agrees that, at a minir and the Supplier enter into a written agr source of the Supplier's liability and the	henyl ethers (each a "RoHS restricted subs ndicate below which, if any, RoHS exempt ovides in this form using appropriate meth will rely on this certification in determinin ers in completing this form, and that Suppl num, itssuppliers have provided certificatio eement with respect to the identified part,t Company's remedies for issues that arise r	stance") in exce ion you believe ods to ensure i g the compliar ier may not ha ons regarding t he terms and co	ropean Union member states) of the part identifiess of the applicable quantity limit identified able may apply. If the part is an assembly with low is accuracy and that such information is true and ce of its products with European Union member independently verified such information. How heir contributions to the part, and those certifica onditions of that agreement, including any warra nation the Supplier provides in this form. In the	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the inty rights and/or remedies provided as part of
RoHS Declaration * 4 - Item(s) does not contain RoHS restricted subst	ances per the definition above except for se	elected exempt	ions Supplier Acceptance	* Accepted
Exemption: 7c-I Electrical and electronic c	omponents containing lead in a glass o	r ceramic other than dielectric ceramic	in capacitors,	e.g. piezoelectronic devices, or in a glass or c	eramic matrix compound.
Exemption List Version	EL-2011/534/EU				
Declaration Signature					
Instructions: Complete all of the required Requester) and click on Submit Form to ha			ice drop-dowi	a. This will display the signature area. Digital	ly sign the declaration (if required by the
Supplier Digital Signature R	astislav Drska	Le			

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Capacitors Ceramic	12.58	mg		Ceramic	prorietary		3.9463	mg
			Supplier	Epoxy resin	Proprietary Data		0.1258	mg
			Supplier	Glass	Proprietary Data		0.1019	mg
			Supplier	Boron (B)	7440-42-8		0.0063	mg
			Supplier	Silver (Ag)	7440-22-4		1.141	mg
			Supplier	Tin (Sn)	7440-31-5		0.239	mg
			Supplier	Misc.	Proprietary Data		0.0302	mg
			Supplier	Barium (Ba)	7440-39-3		4.5955	mg
			В	Nickel (Ni)	7440-02-0		1.4203	mg
			Supplier	Copper (Cu)	7440-50-8		0.9737	mg
DBC	4815.0	mg	Supplier	Aluminum Trioxide (Al2O3)	1344-28-1		1926	mg
			Supplier	Copper (Cu)	7440-50-8		2889	mg
Die	53.33	mg	Supplier	Silicon (Si)	7440-21-3		53.33	mg
Die Attach Solder	98.0	mg	Supplier	Silver (Ag)	7440-22-4		2.94	mg
		-	Supplier	Tin (Sn)	7440-31-5		94.57	mg
			Supplier	Copper (Cu)	7440-50-8		0.49	mg
Lead Frame	5552.0	mg	В	Nickel (Ni)	7440-02-0		1.1104	mg
		-	Supplier	Iron (Fe)	7439-89-6		8.328	mg
			Supplier	Copper (Cu)	7440-50-8		5540.3408	mg
			Supplier	Phosphorus (P)	7723-14-0		2.2208	mg
Mold Compound-Black	10200.0	mg	Supplier	Carbon Black (C)	1333-86-4		102	mg
		-	Supplier	Fused Silica (SiO2)	60676-86-0		8670	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		1428	mg
NTC	4.0	mg		Ceramic	prorietary		2.746	mg
		-	Supplier	Glass	Proprietary Data		0.0368	mg
			Supplier	Cobalt (Co)	7440-48-4		0.126	mg
			Supplier	Boron (B)	7440-42-8		0.0032	mg
			Supplier	Silver (Ag)	7440-22-4		0.04	mg
			Supplier	Tin (Sn)	7440-31-5		0.066	mg
			Supplier	Misc.	Proprietary Data		0.0012	mg
			Supplier	Palladium (Pd)	7440-05-3		0.0936	mg
			В	Nickel (Ni)	7440-02-0		0.5632	mg

			Supplier	Copper (Cu)	7440-50-8		0.324	mg
Plating	246.0	mg	Supplier	Tin (Sn)	7440-31-5		246	mg
Resistor	13.26	mg	Supplier	Silver (Ag)	7440-22-4		1.2452	mg
			Supplier	Bisphenol A, Epichlorohydrin polymer	25036-25-3, 25068- 38-6		0.1876	mg
			Supplier	Fiber Glass (SiO2)	65997-17-3		0.1058	mg
			Supplier	Boron Trioxide (B2O3)	1303-86-2		0.0297	mg
			Supplier	Tin (Sn)	7440-31-5		0.3227	mg
			В	Bismuth Trioxide (Bi2O3)	1304-76-3		0.0044	mg
			Supplier	Magnesium Monoxide (MgO)	1309-48-4		0.1091	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		0.3422	mg
			Supplier	Aluminum Trioxide (Al2O3)	1344-28-1		10.3322	mg
			Supplier	Ruthenium Oxide (RuO2)	12036-10-1		0.0318	mg
			В	Nickel (Ni)	7440-02-0		0.3873	mg
			А	Lead Oxide (PbO)	1317-36-8	7c	0.1498	mg
			Supplier	Chromium Trioxide (Cr2O3)	1308-38-9		0.0119	mg
Wire Bond - Al	186.0	mg	Supplier	Aluminum (Al)	7429-90-5		186	mg